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**INFORMATION DISCLOSURE
CITATION FORM FOR
PATENT APPLICATION
(FORM PTO-1449)
(Substitute)**

Docket No.: 871-011711-US (PAR)

Serial No.: 10/798,142

Applicant(s): DEPIANO et al.

Filing Date: March 11, 2004

Group: 2874

U.S. PATENTS

Initials	Patent Number	Issue Date	Name	Class	Sub-class	Filing date
Aullah	5,825,792	10/20/98	Villeneuve et al.	372	32	
	6,377,592	4/23/02	Auracher et al.	372	9	
	6,094,446	7/25/00	Tei et al.	372	32	
	6,384,947	5/7/02	Ackerman et al.	359	187	
	5,781,572	7/14/98	Tahara et al.	372	34	

U.S. PATENT PUBLICATIONS

Initials	Publication No.	Pub. Date	Name	Class	Sub-class	Filing Date

FOREIGN PATENT DOCUMENTS

Initials	Document Number	Date	Country	Name	Translation? Yes/No/n/a
Aullah	WO 01/11739 JP 07095159	15.02.01 04.07.95	PCT Japan	CORETEK, INC. Tokyo Electric Power Co. Inc.	N/A No

OTHER DOCUMENTS (Title, Author, Date, Pages, Etc., if known)

Aullah	K. Anderson, "Design and Manufacturability Issues of a Co-packaged DFB/MZ Module", IEEE Electronic Components and Technology Conference, 1999, pages 197-200.
Aullah	Patent Abstract of Japan, European Patent Office, JP 07095159, Tokyo electric Power Co. Inc.

Examiner's Signature: Akm E. Ullah

Date Considered: 12 12 05

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